# International TOR Rectifier

## REPETITIVE AVALANCHE AND dv/dt RATED HEXFET®TRANSISTORS THRU-HOLE (TO-204AA/AE)

RATED IRF150 JANTX2N6764 JANTXV2N6764 [REF:MIL-PRF-19500/543] 100V, N-CHANNEL

### **Product Summary**

Part Number	Bvdss	RDS(on)	ΙD	
IRF150	100V	$0.055\Omega$	38A	

The HEXFET® technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry and unique processing of this latest "State of the Art" design achieves: very low on-state resistance combined with high transconductance; superior reverse energy and diode recovery dv/dt capability.

The HEXFET transistors also feature all of the well established advantages of MOSFETs such as voltage control, very fast switching, ease of paralleling and temperature stability of the electrical parameters.

They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high energy pulse circuits.



#### Features:

- Repetitive Avalanche Ratings
- Dynamic dv/dt Rating
- Hermetically Sealed
- Simple Drive Requirements
- Ease of Paralleling

## **Absolute Maximum Ratings**

	Parameter		Units
ID @ VGS = 10V, TC = 25°C Continuous Drain Current		38	
ID @ VGS = 10V, TC = 100°C Continuous Drain Current		24	Α
IDM	Pulsed Drain Current ①	152	
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Max. Power Dissipation	150	W
	Linear Derating Factor	1.2	W/°C
VGS	Gate-to-Source Voltage	±20	V
EAS	Single Pulse Avalanche Energy ②	150	mJ
IAR	Avalanche Current ①	38	Α
EAR Repetitive Avalanche Energy ①		15	mJ
dv/dt	Peak Diode Recovery dv/dt 3	5.5	V/ns
TJ	Operating Junction	-55 to 150	
TSTG Storage Temperature Range			°C
	Lead Temperature	300 (0.063 in. (1.6mm) from case for 10s)	
	Weight	11.5 (typical)	g

For footnotes refer to the last page

## Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

	Parameter	Min	Тур	Max	Units	<b>Test Conditions</b>
BVDSS	Drain-to-Source Breakdown Voltage	100	_		V	VGS = 0V, ID = 1.0mA
ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	Temperature Coefficient of Breakdown Voltage	_	0.13		V/°C	Reference to 25°C, I <sub>D</sub> = 1.0mA
RDS(on)	Static Drain-to-Source On-State		_	0.055	Ω	VGS = 10V, ID =24A@
, ,	Resistance	_	_	0.065	22	VGS =10V, ID =38A @
VGS(th)	Gate Threshold Voltage	2.0	_	4.0	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =250μA
9fs	Forward Transconductance	9.0	_	_	S (0)	V <sub>DS</sub> > 15V, I <sub>DS</sub> =24A4
IDSS	Zero Gate Voltage Drain Current	_	_	25		V <sub>DS</sub> =80V, V <sub>GS</sub> =0V
		_	_	250	μΑ	V <sub>DS</sub> =80V
						$V_{GS} = 0V, T_{J} = 125^{\circ}C$
GSS	Gate-to-Source Leakage Forward	_	_	100	nA	VGS=20V
IGSS	Gate-to-Source Leakage Reverse		_	-100	IIA	VGS =-20V
Qg	Total Gate Charge	50	_	125		VGS =10V, ID= 38A
Qgs	Gate-to-Source Charge	8.0	_	22	nC	V <sub>DS</sub> =50V
Q <sub>gd</sub>	Gate-to-Drain ('Miller') Charge	25	_	65		
<sup>t</sup> d(on)	Turn-On Delay Time	_	_	35		V <sub>DD</sub> =50V, I <sub>D</sub> =38A,
tr	Rise Time	_	_	190	ns	$V_{GS} = 10V, R_{G} = 2.35\Omega$
td(off)	Turn-Off Delay Time	_	_	170	115	
tf	Fall Time	_		130		
LS + LD	Total Inductance	_	6.1		nΗ	Measured from the center of drain pad to center of source pad
Ciss	Input Capacitance	_	3700			VGS = 0V, VDS =25V
Coss	Output Capacitance	_	1100		рF	f = 1.0MHz
C <sub>rss</sub>	Reverse Transfer Capacitance	_	200	_		

## Source-Drain Diode Ratings and Characteristics

	Parameter		Min	Тур	Max	Units	Test Conditions
Is	Continuous Source Current (Body Diode)		_	_	38	Α	
ISM	Pulse Source Current (Body Diode) ①		_	_	152	'`	
VSD	Diode Forward Voltage		_	_	1.9	V	$T_j = 25$ °C, $I_S = 38A$ , $V_{GS} = 0V$ ④
trr	Reverse Recovery Time		_	_	500	nS	Tj = 25°C, I <sub>F</sub> = 38A, di/dt ≤100A/μs
QRR	RR Reverse Recovery Charge		_	_	2.9	μc	V <sub>DD</sub> ≤ 30V ④
ton	Forward Turn-On Time Intr	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by LS + LD.					

## **Thermal Resistance**

	Parameter	Min	Тур	Max	Units	Test Conditions
RthJC	Junction to Case	_	_	0.83	°C/W	
RthJA	Junction to Ambient	_	_	30	C/VV	Typical socket mount

For footnotes refer to the last page

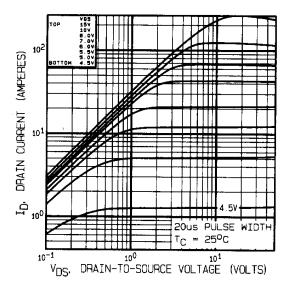


Fig 1. Typical Output Characteristics

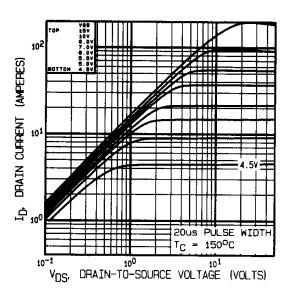


Fig 2. Typical Output Characteristics

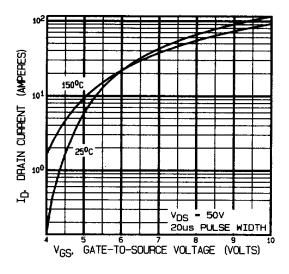
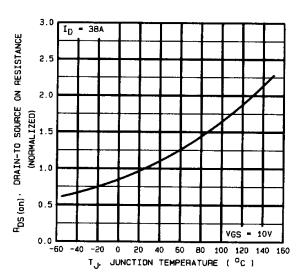
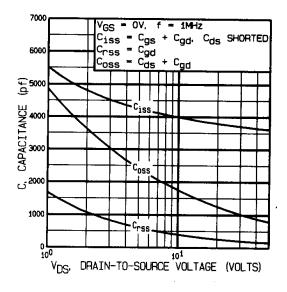
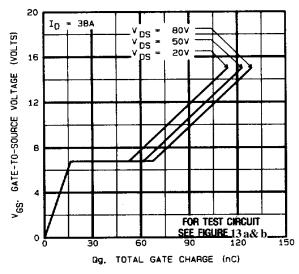


Fig 3. Typical Transfer Characteristics



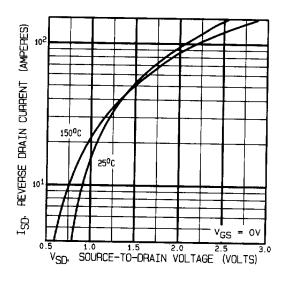
**Fig 4.** Normalized On-Resistance Vs. Temperature





**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage

**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage



**Fig 7.** Typical Source-Drain Diode Forward Voltage

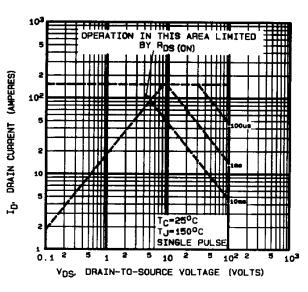
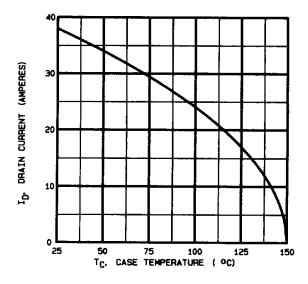


Fig 8. Maximum Safe Operating Area



**Fig 9.** Maximum Drain Current Vs. Case Temperature

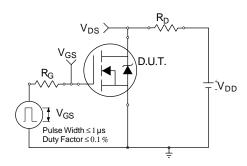


Fig 10a. Switching Time Test Circuit

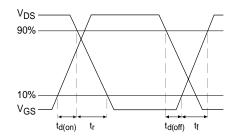


Fig 10b. Switching Time Waveforms

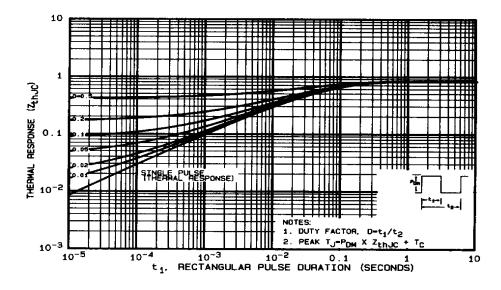


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

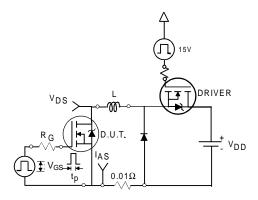


Fig 12a. Unclamped Inductive Test Circuit

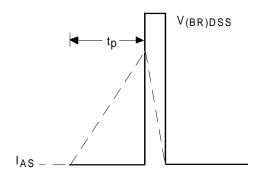


Fig 12b. Unclamped Inductive Waveforms

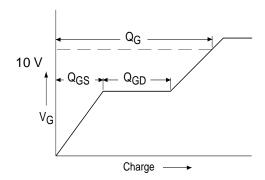
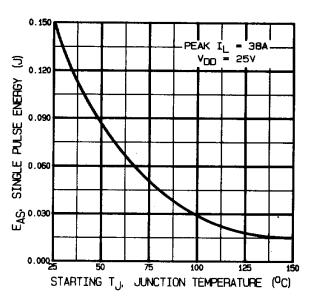


Fig 13a. Basic Gate Charge Waveform



**Fig 12c.** Maximum Avalanche Energy Vs. Drain Current

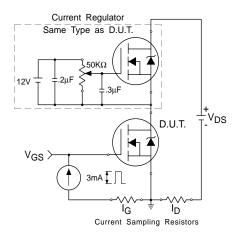


Fig 13b. Gate Charge Test Circuit

**IRF150** 

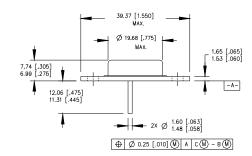
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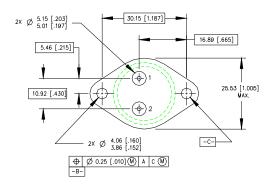
#### **Foot Notes:**

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- ②  $V_{DD} = 50V$ , starting  $T_J = 25$ °C, Peak IL = 38A, VGS =10V

- ③ ISD ≤ 38A, di/dt ≤300A/ $\mu$ s, V<sub>DD</sub>≤ 100V, T<sub>J</sub> ≤ 150°C Suggested RG =  $2.35 \Omega$
- 4 Pulse width  $\leq 300 \,\mu s$ ; Duty Cycle  $\leq 2\%$

### Case Outline and Dimensions —TO-204AE (Modified TO-3)





#### PIN ASSIGNMENTS

- 1 SOURCE
- 2 GATE 3 DRAIN (CASE)

#### NOTES:

- 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982.
- CONTROLLING DIMENSION: INCH.
- DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- OUTLINE CONFORMS TO JEDEC OUTLINE TO-204AE.

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